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To: Assistant Commissioner of Patents
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From: Stephen B. Ackerman

Subject: Serial No.: 10/042,074
Filing Date: 01/08/02
Inventor: D. N. Yaung, et al
Title: Grid Metal Design for Large Density CMOS Image Sensor

REQUEST TO CORRECT FILING RECEIPT

Dear Sir:

On the copy of the enclosed Filing Receipt, there are errors in the list of Applicants. The Applicants' residences are incorrect. Following is a list of the Applicants' names and their corrected residences:

Dun-Nian Yaung, Taipei, Taiwan
Shou-Gwo Wu, Hsin-Chu City, Taiwan
Chien-Hsien Tseng, Hsin-Chu, Taiwan.

Please make the necessary changes to correct the errors on the Filing Receipt. A copy of the filed Declaration is enclosed for clarification.

If there are any questions, please contact the undersigned attorney at (845) 452-5863. Thank you for your attention to this matter.

Respectfully Submitted,

Stephen B. Ackerman, Reg. No. 37,761

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APPLICATION NUMBER	FILING DATE	GRP ART UNIT	FIL FEE REC'D	ATTY. DOCKET NO	DRAWINGS	TOT CLAIMS	IND CLAIMS
10/042,074	01/08/2002	2825	1352	TS01-450	3	40	6

CONFIRMATION NO. 3909

FILING RECEIPT



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 STEPHEN B. ACKERMAN
 20 MCINTOSH DRIVE
 POUGHKEEPSIE, NY 12603


Date Mailed: 02/01/2002

Receipt is acknowledged of this nonprovisional Patent Application. It will be considered in its order and you will be notified as to the results of the examination. Be sure to provide the U.S. APPLICATION NUMBER, FILING DATE, NAME OF APPLICANT, and TITLE OF INVENTION when inquiring about this application. Fees transmitted by check or draft are subject to collection. Please verify the accuracy of the data presented on this receipt. If an error is noted on this Filing Receipt, please write to the Office of Initial Patent Examination's Customer Service Center. Please provide a copy of this Filing Receipt with the changes noted thereon. If you received a "Notice to File Missing Parts" for this application, please submit any corrections to this Filing Receipt with your reply to the Notice. When the USPTO processes the reply to the Notice, the USPTO will generate another Filing Receipt incorporating the requested corrections (if appropriate).

Applicant(s)

 Dun-Nian Yaung, Taipei, CHINA;
 Shou-Gwo Wu, Hsin-Chu City, CHINA;
 Chien-Hsien Tseng, Hsinchu, CHINA;

Assignment For Published Patent Application

Taiwan Semiconductor Manufacturing Company;

Domestic Priority data as claimed by applicant

Foreign Applications

If Required, Foreign Filing License Granted 02/01/2002

Projected Publication Date: Request for Non-Publication Acknowledged

Non-Publication Request: Yes

Early Publication Request: No

Title

Grid metal design for large density CMOS image sensor

Preliminary Class

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